	DEC( 06-1	2-2				
				EET U.S. DEPARTMENT OF CO Patent and Trade		
(			475	And the second s		
To the Honorable Commissioner of Patents a 101377175  To the Honorable Commissioner of Patents a 101377175						
1	Name of conveying party(ies):	2	Name and address	ss of receiving party(ies):	PTG	
	San-De Tzu		Taiwan Semicond No. 121 Park Ave Science-Based In Hsin-Chu, Taiwar	dustrial Park	Jessa U.S. 09/58518	
3	Nature of conveyance: ■ Assignment		Additional name(s) (	3 address(es) attached □ Yes ∞ No		
	☐ Security Agreement ☐ Change of Name					
	Other:		_			
	Execution Date: March 13, 2000		09,585	189		
4	Application number(s) or patent number(s):					
	If this document is being filed together with a new application, the execution date of the application is: 03-13-00					
	A. Patent Application No(s).		B. Patent No(s)			
Additional numbers attached? □ Yes ≅ No						
5	Name and address of party to whom correspondence concerning document should be mailed:	6	Total number of a	pplications and patents involved	:	
	RANDY W. TUNG	7	Total fee (37 CFR	\$3.41) \$40	0.00	
	Tung & Associates					
	838 W. Long Lake Road Suite 120		☑ Enclose	<b>d</b>		
	Bloomfield Hills, Michigan 48302	<u> </u>		ed to be charged to deposit acc	ount	
		8	Deposit Account	Number: 50-0484		
			(Attach duplicate account)	copy of this page if paying by de	posit	
	DO NOT USE THIS SPACE					
9	Statement and signature.					
To the best of my knowledge and belief the foregoing information is true god correct and any attached copy is a true copy of the original document.					copy of	
	Randy W. Tung Name of Person Signing Registration No. 31,311  Signature	<del></del>	40	June 1, 2000 Date		
Total number of pages including cover sheet, attachments, and document : 3						
Mail documents to be recorded with required cover sheet information to:						
Commissioner of Patents & Trademarks, Box Assignments, 200-272 Washington, D.C. 20231						

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06/09/2000 PNLLE 02 FC:581

PATENT REEL: 010833 FRAME: 0949

67,200-272 1999-532

**ASSIGNMENT** 

WHEREAS, I, SAN-DE TZU have invented certain improvements in METHOD

FOR FABRICATING A MULTIPLE MASKING LAYER PHOTOMASK for which I am about

to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, I, SAN-DE TZU by these

presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory

of the United States of America and all foreign countries, the entire right, title and interest, including

all priority rights under the International Convention associated with each country of the Union, in

and to said invention as described in the patent application executed by me on the 13th day of

March , 2000, preparatory to obtaining Letters Patent of the United States thereon, and

in and to said application and any Letters Patent that may be granted in pursuance of said application

and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue

of any such patent, and in and to any patent applications which may be filed on said invention in

countries foreign to the United States and any Letters Patent granted thereon.

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PATENT 10833 FRAME: 0

REEL: 010833 FRAME: 0950

I further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and I further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

San - De Zen SAN-DE TZU

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

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PATENT REEL: 010833 FRAME: 0951